# TLP3061(S),TLP3062(S),TLP3063(S)

**OFFICE MACHINE** HOUSEHOLD USE EQUIPMENT TRIAC DRIVER SOLID STATE RELAY

The TOSHIBA TLP3061 (S), TLP3062 (S), TLP3063 (S) consist of a zero voltage crossing turn-on photo-triac optically coupled to an infrared emitting diode in a six lead plastic DIP package.

Peak Off-State Voltage : 600 V (min)

Trigger LED Current : 15 mA (max) (TLP3061(S))

> 10 mA (max) (TLP3062(S)) 5 mA (max) (TLP3063(S))

On-State Current : 100 mA (max)

Isolation Voltage : 5000 Vrms (min)

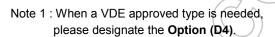
UL-recognized : UL 1577, File No.E67349

: CSA Component Acceptance Service No.5A cUL-recognized

File No.E67349

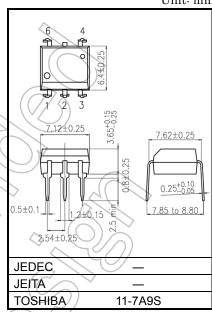
: GB4943.1,GB8898 Japan Factory CQC-approved

: EN 60747-5-5, EN 62368-1 (Note1) VDE-approved



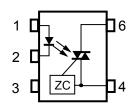
Construction mechanical rating

	7.62 mm pitch	10.16 mm pitch
	Standard Type	TLPxxxxF type
Creepage Distance	7.0 mm (Min)	8.0 mm (Min)
Clearance	7.0 mm (Min)	8.0 mm (Min)
Insulation Thickness	0.5 mm (Min)	0.5 mm (Min)



weight: 0.39g (typ.)

#### **Pin Configuration** (top view)



- 1: Anode
- 2: Cathode
- 3: N.C.
- 4:Terminal 1
- 6:Terminal 2

ZC:Zero-cross Circuit

Start of commercial production 1996-09

#### Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit	
	Forward current	l <sub>F</sub>	50	mA	
	Forward current derating (Ta ≥ 53°	ΔIF/°C	-0.7	mA / °C	
	Peak forward current (100 µs pulse, 100 pps)			1	Ą
LED	Power dissipation		PD	100	mW
	Power dissipation derating (Ta ≥ 5	3°C)	ΔP <sub>D</sub> /°C	-1.4	mW / °C
	Reverse voltage		VR	5	V
	Junction temperature		Tj	125	(°¢/<
	Off-state output terminal voltage		VDRM	600	
	On-state RMS current	Ta = 25°C Ta = 70°C	I <sub>T(RMS)</sub>	100	mA
	On–state current derating (Ta ≥ 25°C)		ΔIT / °C	-1,1	mA/°C
Detector	Peak on–state current (100μs pulse, 120 pps)	I <sub>TP</sub>	2	A	
De	Peak nonrepetitive surge current (P <sub>w</sub> = 10 ms)	ITSM	(//1.2)	Ą	
	Power dissipation		PD (	300	mW
	Power dissipation derating (Ta ≥ 2	ΔP <sub>D</sub> /°C	-4.0	mW//°C	
	Junction temperature		⟨ŋ( <u> </u>	Tj 115	
Storage temperature range			T <sub>stg</sub>	−55 to 150	) () ()
Operat	ing temperature range	Topr	-40 to 100 (	//°¢	
Lead soldering temperature (10 s)			T <sub>sol</sub>	260	Ŷ
Total p	ackage power dissipation	PT	330	mW	
Total p (Ta ≥ 2	ackage power dissipation derating 25°C)	ΔPT / °C	4.4	mW / °C	
	on voltage 0 s., R.H.≤ 60 %)	BVS	5000	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) Device considered a two terminal device: Pins 1, 2 and 3 shorted together and pins 4 and 6 shorted together.

### **Recommended Operating Conditions**

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V <sub>AC</sub>	_	_	240	Vac
Forward current	l <sub>F</sub> *	15	20	25	mA
Peak on-state current	ITP	_	_	1	Α
Operating temperature	T <sub>opr</sub>	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

<sup>\*</sup> In the case of TLP3062

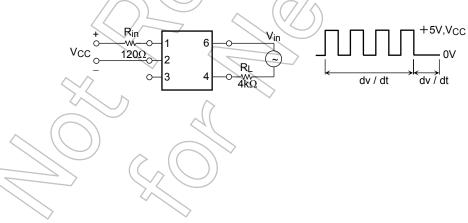
## Individual Electrical Characteristics (Ta = 25°C)

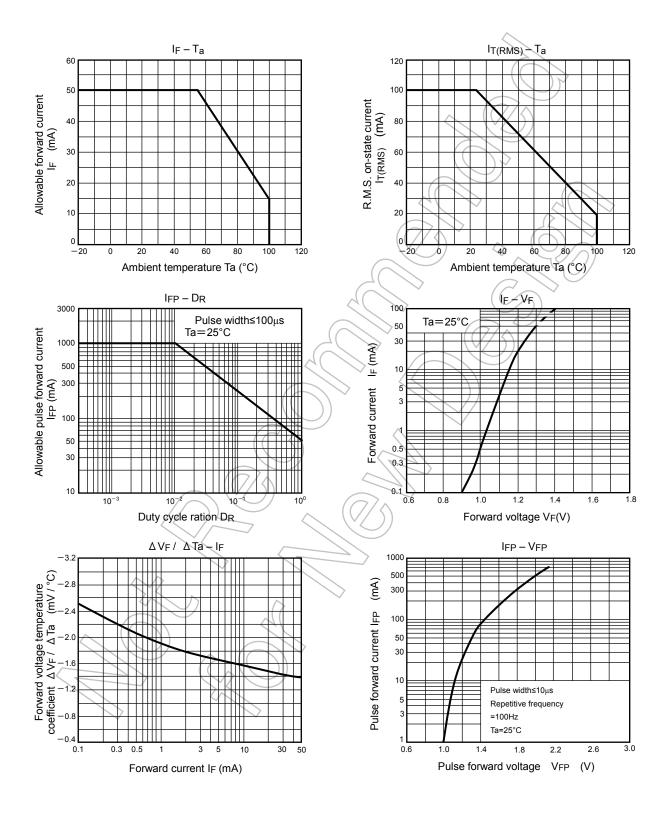
	Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μА
	Capacitance	Ст	V = 0 V, f = 1 MHz	//	10	_	pF
	Peak off-state current	IDRM	V <sub>DRM</sub> = 600 V		10	1000	nA
	Peak on-state voltage	V <sub>TM</sub>	I <sub>TM</sub> = 100 mA		1.7	3.0	V
tor	Holding current	lн	0	) } 	0.6	_	mA
Detector	Critical rate of rise of off–state voltage	dv / dt	V <sub>in</sub> = 240 Vrms, Ta = 85 °C (Fig.1)	200	500	_	V / μs
	Critical rate of rise of commutating voltage	dv / dt (c)	V <sub>in</sub> = 60 Vrms, I <sub>T</sub> = 15 mA (Fig.1)	_	0.2	_	V / μs

## Coupled Electrical Characteristics (Ta = 25°C)

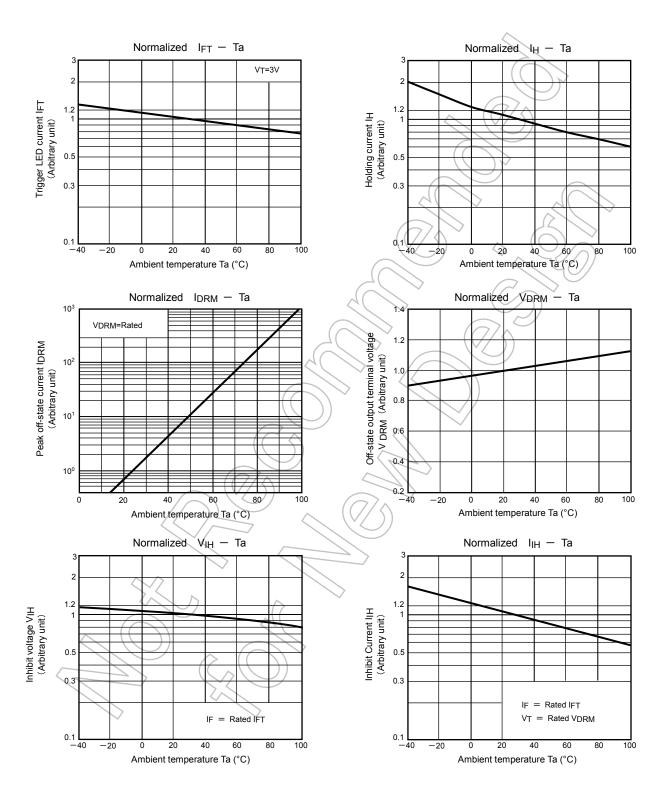
Characteris	stic	Symbol	Test Condition	Min	Тур	Max.	Unit
	TLP3061(S)					15	
Trigger LED current	TLP3062(S)	IFT	V <sub>T</sub> = 3 V		5	10	mA
	TLP3063(S)				_	5	
Inhibit voltage		VIH	I <sub>F</sub> = rated I <sub>FT</sub>	) –		50	V
Leakage in inhibited state	•	IIH	IF = rated IFT VT = rated VDRM	_	100	300	μА
Capacitance input to outp	out	es	V <sub>S</sub> = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance		Rs	V <sub>S</sub> = 500 V, R.H.≤ 60 %	5×10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
Isolation voltage	(	BVs	AC, 60 s	5000	_	_	Vrms

Fig. 1 dv / dt test circuit





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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